IN THE CLAIMS:

Claims 1-5. (Cancelled)

- 6. (Currently Amended) A method of preparing a molding, comprising the steps of:
- (a) providing a hydrosilylated polymer obtained by reacting at least one hydridosilsesquioxane compound of the following formula (1):

$$(H S i O_{3/2})_n$$
 (1)

wherein n is an integer of 4-1000, with at least one divinylsiloxane compound of the following formula (2):

$$CH_2 = CH - SiR_2 - O - (SiR_2 - O)_q - (SiR_2 - O)q' - SiR_2 - CH = CH_2$$
 (2)

wherein R and R' are independently selected from alkyl groups, substituted alkyl groups, aryl groups and substituted aryl groups, and q and q' are each an integer of 0 or more, and

- (b) heating the hydrosilylated polymer in an atmosphere of an inert gas and at a temperature higher than the softening point or melting point thereof in a mold cavity to cure the polymer.
- 7. (Originally presented) A method as claimed in claim 6, wherein step (b) is performed under a reduced pressure.

- 8. (Cancelled).
- 9. (Originally presented) A method as claimed in claim 6, wherein n in the formula (1) of said hydridosilsesquioxane is 8.
- 10. (Originally presented) A method as claimed in claim 6, wherein said heating is at 50-250°C.
- 11. (Newly Added) A method of preparing a molding, comprising the steps of:
- (a) providing a hydrosilylated polymer obtained by reacting at least one hydridosilsesquioxane compound of the following formula (1):

$$(H S i O_{3/2})_n \tag{1}$$

wherein n is an integer of 4-1000, with at least one divinylsiloxane compound of the following formula (2):

$$CH_2 = CH - SiR_2 - O - (SiR_2 - O)_q - (SiR'_2 - O)q' - SiR_2 - CH = CH_2$$
 (2)

wherein R and R' are independently selected from alkyl groups, substituted alkyl groups, aryl groups and substituted aryl groups, and q and q' are each an integer of 0 or more, and

- (b) heating the hydrosilylated polymer under a reduced pressure and at a temperature higher than the softening point or melting point thereof in a mold cavity to cure the polymer.
- 12. (Newly added) A method of preparing a molding, comprising the steps of:
- (a) providing a hydrosilylated polymer obtained by reacting at least one hydridosilsesquioxane compound of the following formula (1):

$$(H S i O_{3/2})_n$$
 (1)

wherein n is an integer of 4-1000, with at least one divinylsiloxane compound of the following formula (2):

$$CH_2 = CH - SiR_2 - O - (SiR_2 - O)_q - (SiR'_2 - O)q' - SiR_2 - CH = CH_2$$
 (2)

wherein R and R' are independently selected from alkyl groups, substituted alkyl groups, aryl groups and substituted aryl groups, and q and q' are each an integer of 0 or more; and

- (b) heating the hydrosilylated polymer at a temperature higher than the softening point or melting point thereof under a reduced pressure;
 - (c) then heating the hydrosilylated polymer at ambient pressure; and
 - (d) heating the product obtained in step (c) in a mold cavity to complete the curing of the

| hydrosilylated polymer, steps (b) and (c) being successively repeated at least twice before step |
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| (d). |
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| 13. (Newly added) A method as claimed in claim 12, wherein n in the formula (1) of said |
| hydridosilsesquioxane is 8. |
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| 14. (Newly added) A method as claimed in claim 12, wherein said heating is at 50-250°C. |
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| 15. (Newly added) A method as claimed in claim 12 wherein said step (c) is performed in an |
| inert gas atmosphere. |
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| 16. (Newly added) A method as claimed in claim 15 wherein said step (d) is performed in an |
| inert atmosphere. |
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| 17. (Newly added) A method as claimed in claim 12 wherein said step (d) is performed in an |
| inert gas atmosphere. |
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| 18. (Newly added) A method as claimed in claim 17 wherein said step (b) is repeated at |
| 5 |

successively higher temperatures.

- 19. (Newly added) A method as claimed in claim 16 wherein said step (b) is repeated at successively higher temperatures.
- 20. (Newly added) A method as claimed in claim 15 wherein said step (b) is repeated at successively higher temperatures.
- 21. (Newly added) A method as claimed in claim 12 wherein said step (b) is repeated at successively higher temperatures.